

WSP4953

Dual P-Ch MOSFET

General Description

The WSP4953 is the highest performance trench P-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSP4953 meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

Product Summery

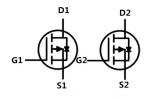
BVDSS	RDSON	ID
-30V	60mΩ	-5.3A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

SOP8 Pin Configuration





Symbol	Parameter	Rating	Units	
V _{DS}	Drain-Source Voltage	-30	V	
V _{GS}	Gate-Source Voltage	±20	V	
I _D @T _C =25℃	Continuous Drain Current, $-V_{GS} @ -10V^1$ -5.3		A	
I _D @T _C =100℃	Continuous Drain Current, -V _{GS} @ -10V ¹ -4.6		A	
I _{DM}	Pulsed Drain Current ²	-12	А	
P _D @T _C =25℃	Total Power Dissipation ³ 1.5		W	
T _{STG}	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{eja}	Thermal Resistance Junction-Ambient ¹		85	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		36	°C/W

Absolute Maximum Ratings



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Electrical Characteristics (T_J=25 ^(C), unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, I_D=-1mA		-0.02		V/℃
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-3A		60	90	mΩ
		V _{GS} =-4.5V , I _D =-1.5A		90	120	
V _{GS(th)}	Gate Threshold Voltage		-1.0	-1.5	-2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			4.32		mV/℃
	Drain Source Lookage Current	V_{DS} =-24V , V_{GS} =0V , T_J =25 $^\circ\!C$			-1	uA
I _{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}\text{=-24V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}55^\circ\!\mathrm{C}$			-5	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm20V$, V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-3A		5.5		S
Rg	Gate Resistance	V_{DS} =0V , V_{GS} =0V , f=1MHz		24	48	Ω
Qg	Total Gate Charge (-4.5V)	V _{DS} =-20V , V _{GS} =-4.5V , I _D =-5A		5.22		
Q _{gs}	Gate-Source Charge			1.25		nC
Q _{gd}	Gate-Drain Charge			2.3		
T _{d(on)}	Turn-On Delay Time			18.4		
Tr	Rise Time	V _{DD} =-15V , V _{GS} =-10V , R _G =3.3Ω I _D =-1Α		11.4		
T _{d(off)}	Turn-Off Delay Time			39.4		- ns
T _f	Fall Time			5.2		
Ciss	Input Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		463		
C _{oss}	Output Capacitance			82		pF
C _{rss}	Reverse Transfer Capacitance			68]

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,4}	$-V_G=V_D=0V$, Force Current			-5.3	А
I _{SM}	Pulsed Source Current ^{2,4}				-12	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25℃			-1	V

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3.The power dissipation is limited by 150 °C junction temperature

4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



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Typical Characteristics

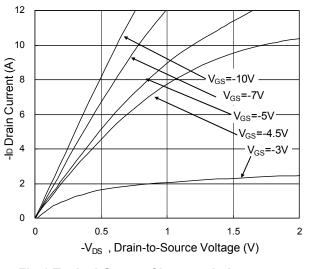
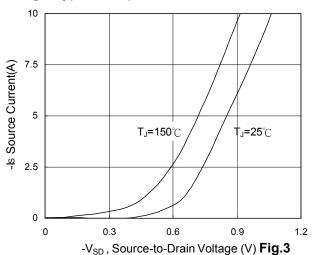


Fig.1 Typical Output Characteristics





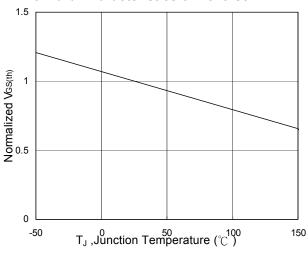


Fig.5 Normalized V_{GS(th)} vs. T_J

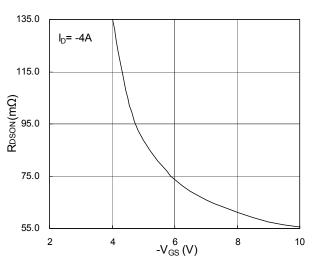


Fig.2 On-Resistance vs. G-S Voltage

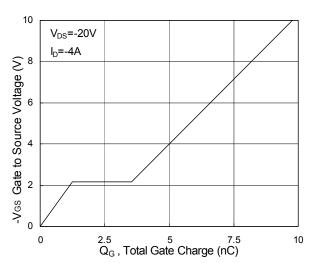
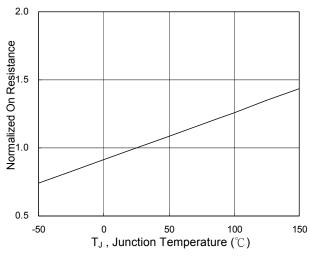
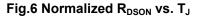


Fig.4 Gate-Charge Characteristics





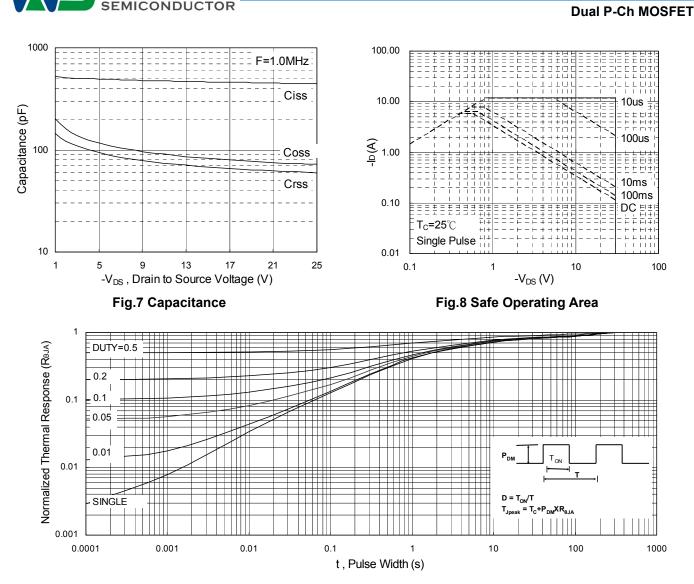
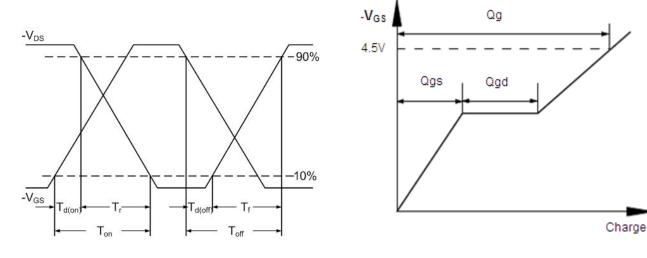
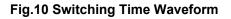


Fig.9 Normalized Maximum Transient Thermal Impedance





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Fig.11 Gate Charge Waveform

WSP4953



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